

TOSHIBA PHOTOINTERRUPTER INFRARED LED + PHOTO IC

TLP1034

PRINTER, ELECTRONIC TYPEWRITER, FACAIMILE

COPYING MACHINE, LATHER BEAMING PRINTER

VCR, VIDEODISC, COMPACT DISC

VARIOUS POSITION DETECTION

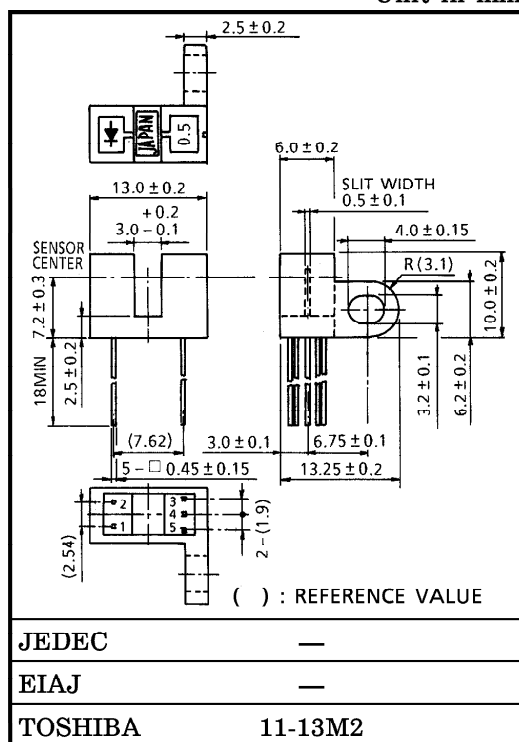
TLP1034 is a digital output photointerrupter with an GaAs infrared LED and a high sensitive and high gain Si photo IC combined.

This photointerrupter has a response speed faster than the photo transistor output and is capable of high speed position detection.

Further because of large output current and a built-in Schmitt trigger circuit, this photointerrupter is connectable directly to a microcomputer or logic IC. Its output becomes low level when the light is shielded. The TLP1024 with a pull-up resistor in the same shape as this photointerrupter is also available.

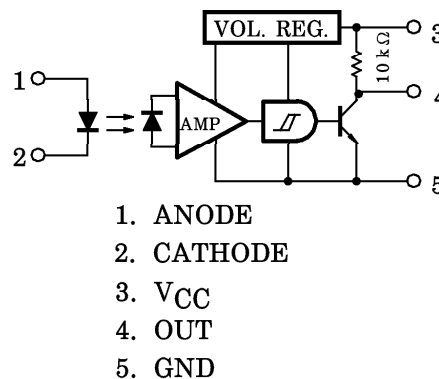
- Side mounting type
- Gap : 3mm
- Resolution : Slit width 0.5mm
- Digital output (with a pull-up resistor)
- Directly connectable to TTL, LSTTL and CMOS.
- Threshold input current : $I_{FLH}=4\text{mA (Max.)}$ at $T_a=25^\circ\text{C}$
- Operating supply voltage : $V_{CC}=4.5\sim 17\text{V}$
- Built-in Schmitt trigger circuit
- Fast response speed : $t_{PLH}=3\mu\text{s}$, $t_{PHL}=6\mu\text{s (Typ.)}$
- Detector side is of visible light cut type.

Unit in mm



Weight : 0.87g (Typ.)

PIN CONNECTION



961001EBC2

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MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
LED	Forward Current	I_F	50	mA
	Forward Current Derating (Ta > 25°C)	$\Delta I_F / ^\circ\text{C}$	-0.33	mA / °C
	Reverse Voltage	V_R	5	V
DETECTOR	Supply Voltage	V_{CC}	17	V
	Output Current	I_O	50	mA
	Power Dissipation	P_O	250	mW
	Power Dissipation Derating (Ta > 25°C)	$\Delta P_O / ^\circ\text{C}$	-3.33	mW / °C
Operating Temperature Range		T_{opr}	-25~85	°C
Storage Temperature Range		T_{stg}	-40~100	°C
Soldering Temperature (5s)		T_{sol}	260	°C

RECOMMENDED OPERATING CONDITIONS

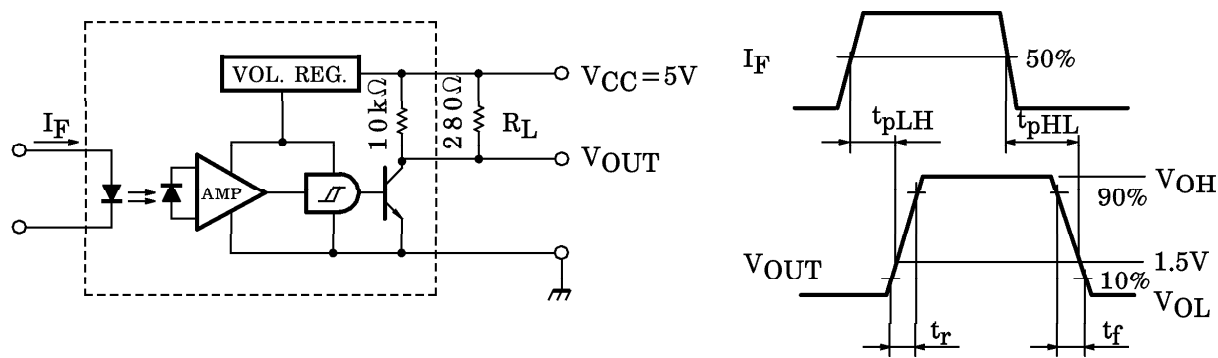
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED Forward Current	I_F	14*	—	20	mA
Supply Voltage	V_{CC}	4.5	5	17	V
Low Level Output Current	I_{OL}	—	—	16	mA
Operating Temperature	T_{opr}	-25	—	85	°C

* 14mA is a value when 50% LED deterioration is taken into consideration.
Initial threshold input current shall be 7mA MAX.

OPTO-ELECTRICAL CHARACTERISTICS (Unless Otherwise Specified, Ta = -25~85°C, VCC = 4.5~5.5V)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
LED	Forward Current	V_F	$I_F=10\text{mA}$, $T_a=25^\circ\text{C}$	1.00	1.15	1.30	V
	Reverse Current	I_R	$V_R=5\text{V}$, $T_a=25^\circ\text{C}$	—	—	10	μA
	Peak Emission Wavelength	λ_P	$I_F=15\text{mA}$, $T_a=25^\circ\text{C}$	—	940	—	nm
DETECTOR	Supply Voltage	V_{CC}	—	4.5	—	17	V
	Low Level Supply Current	I_{CCL}	$I_F=0$	—	—	6.0	mA
			$I_F=0$, $V_{CC}=17\text{V}$	—	—	7.5	
	High Level Supply Current	I_{CCH}	$I_F=15\text{mA}$	—	—	3.0	mA
			$I_F=15\text{mA}$, $V_{CC}=17\text{V}$	—	—	3.2	
	Low Level Output Voltage	V_{OL}	$I_{OL}=16\text{mA}$, $I_F=0$ $T_a=25^\circ\text{C}$	—	0.07	0.3	V
			$I_{OL}=16\text{mA}$, $I_F=0$ $V_{CC}=17\text{V}$	—	—	0.4	
	High Level Output Voltage	V_{OH}	$I_F=15\text{mA}$	$0.9V_{CC}$	—	—	V
	Peak Sensitivity Wavelength	λ_P	$T_a=25^\circ\text{C}$	—	900	—	nm
COUPLED	Threshold Input Current (H→L)	I_{FLH}	$T_a=25^\circ\text{C}$	—	—	4	mA
			$V_{CC}=17\text{V}$	—	—	7	
	Hysteresis Ratio	I_{FHL}/I_{FLH}	—	—	0.67	—	
	Propagation Delay Time	L→H t_{pLH}	$V_{CC}=5\text{V}$, $I_F=15\text{mA}$ $R_L=280$, $T_a=25^\circ\text{C}$ (Note)	—	3	—	μs
		H→L t_{pHL}		—	6	—	
	Rise Time	t_r		—	0.1	—	
	Fall Time	t_f		—	0.05	—	

NOTE : SWITCHING TIME TEST CIRCUIT



PRECAUTION

Please be careful of the followings.

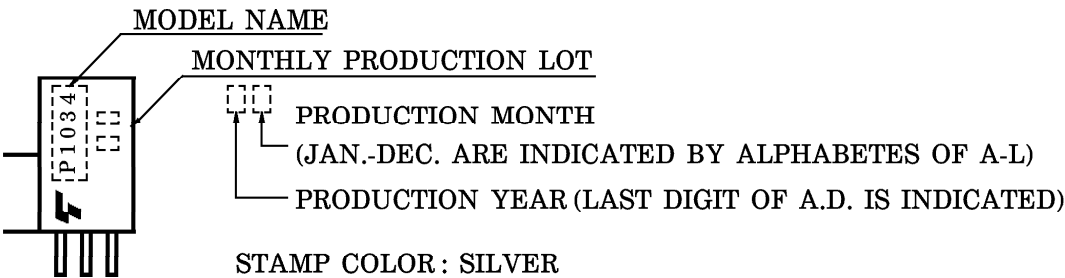
- 1. Soldering should be performed after lead forming.
- 2. If chemical are used for cleaning, the soldered surface only shall be cleaned with chemicals avoiding the whole cleaning of the package.
- 3. The container is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol, and aliphatic hydrocarbons however, with pectochemicals (such as benzene, toluene, and acetone), alkali, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate becomes cracked, swollen, or melted. Please take care when chosing a packaging material by referencing the table below.

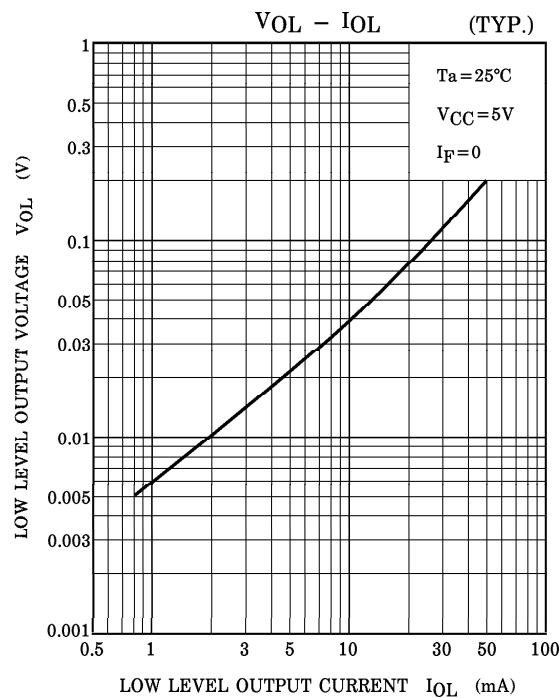
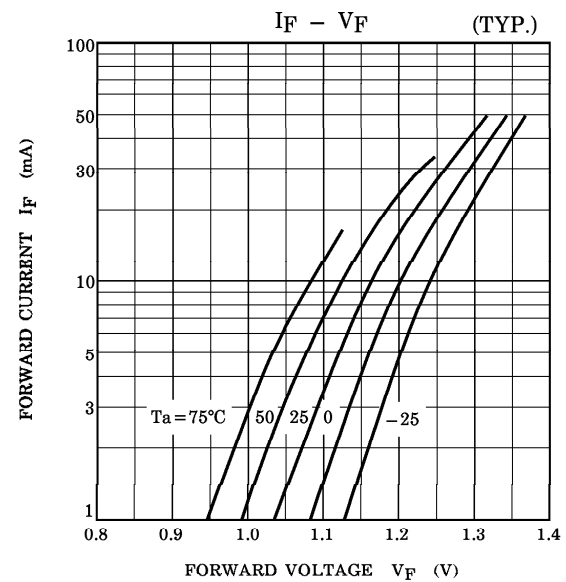
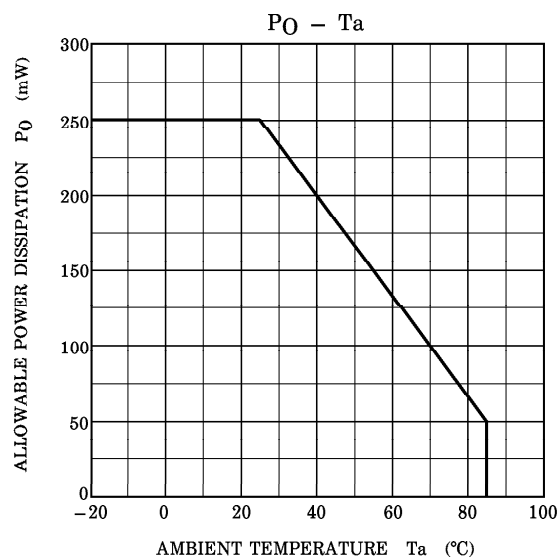
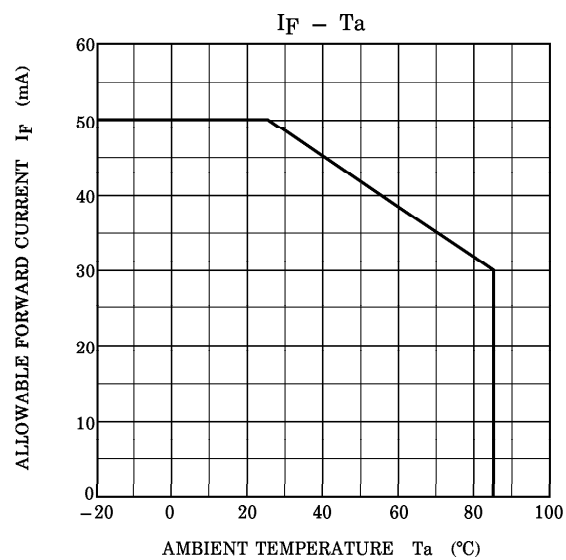
<Chemicals to avoid with polycarbonate>

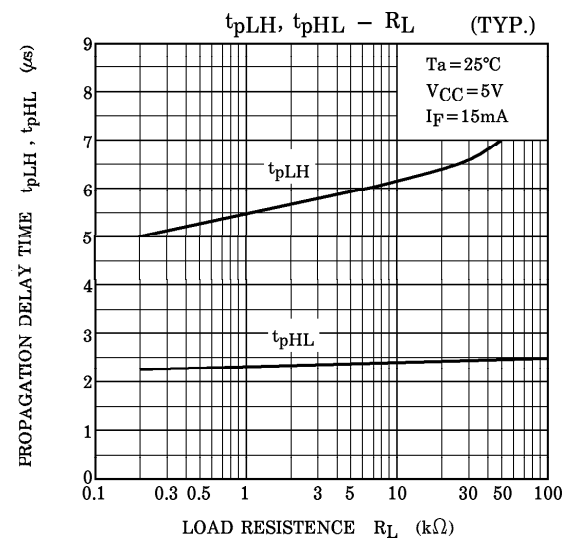
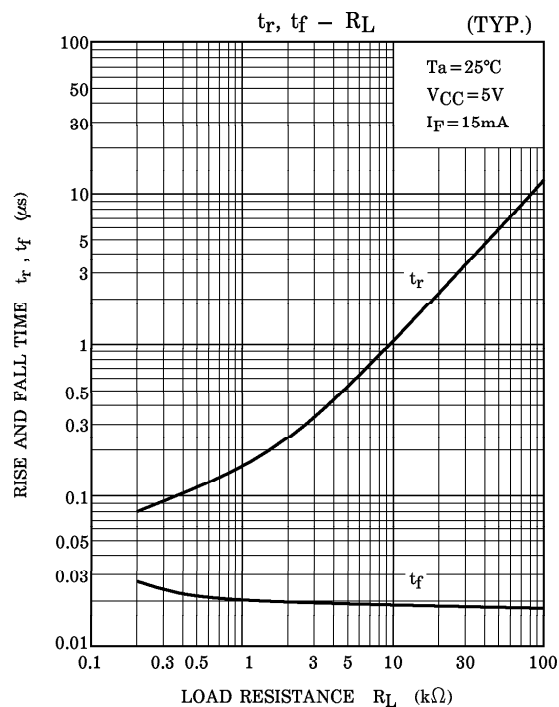
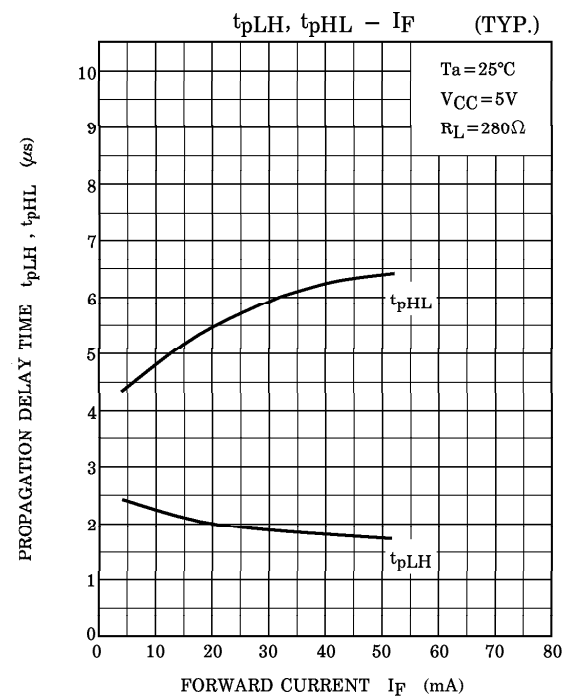
	PHENOMENON	CHEMICALS
A	Little deterioration but staining	<ul style="list-style-type: none">• nitric acid (low concentration), hydrogen peroxide, chlorine
B	Cracked, crazed, or swollen	<ul style="list-style-type: none">• acetic acid (70% or more)• gasoline• methyl ethyl ketone, ehtyl acetate, butyl acetate• ethyl methacrylate, ethyl ether, MEK• acetone, m-amino alcohol, carbon tetrachloride• carbon disulfide, trichloroethylene, cresol• thinners, oil of turpentine• triethanolamine, TCP, TBP
C	Melted { } : Used as solvent.	<ul style="list-style-type: none">• concentrated sulfuric acid• benzene• styrene, acrylonitrile, vinyl acetate• ethylenediamine, diethylenediamine• {chloroform, methyl chloride, tetrachloromethane, dioxane, } {1, 2-dichloroethane }
D	Decomposed	<ul style="list-style-type: none">• ammonia water• other alkali

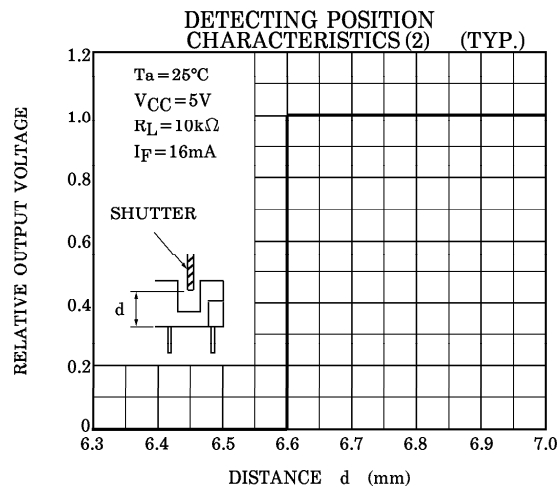
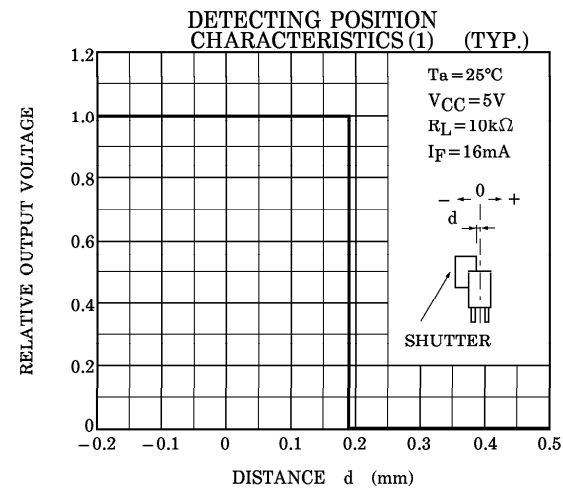
- 4. During 100 μ s after turning on V_{CC}, output voltage changes for stabilizing the inner circuit.
- 5. Supply the by-pass condenser up to 0.01 μ F between V_{CC} and GND near device to stabilize the power supply line.
- 6. Screw shall be tightened to clamping torque of 0.59N·m.

PRODUCT INDICATION





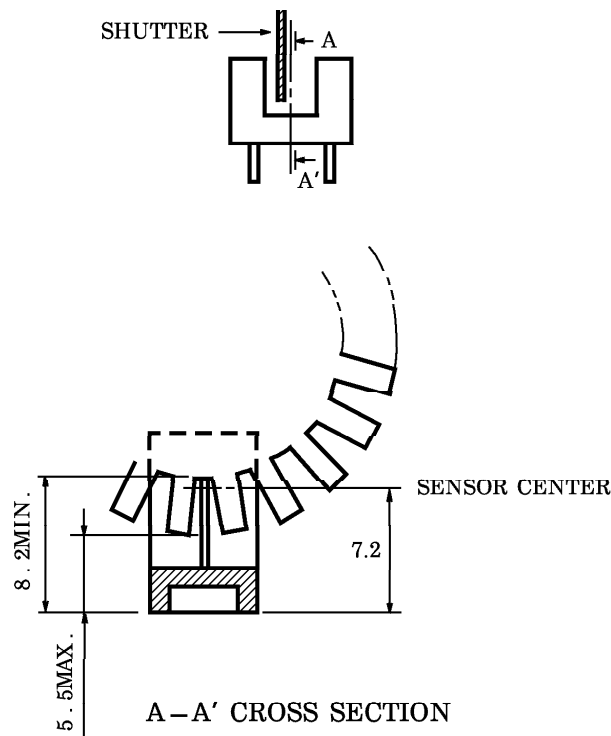




POSITIONING OF SHUTTER AND DEVICE

To operate correctly, make sure that the shutter and the device are positioned as shown in the figure below.

The slit pitch of the shutter must be set wider than the slit width of the device.
Determine the width taking the switching time into consideration.



UNIT IN : mm